

OKI Semiconductor
MR27T6402G

Oki, Network Solutions
for a Global Society

FEDR27T6402G-02-01 Issue Date: Mar. 12, 2002

4M-Word \times 16-Bit or 8M-Word \times 8-Bit P2ROM

FEATURES

4,194,304-word × 16-bit/8,388,608-word × 8-bit electrically switchable configuration
2.7 V to 3.6 V power supply
Access time 90 ns MAX

- Operating current 30 mA MAX
- Standby current $10 \,\mu\text{A MAX}$
- · Input/Output TTL compatible
- · Three-state output

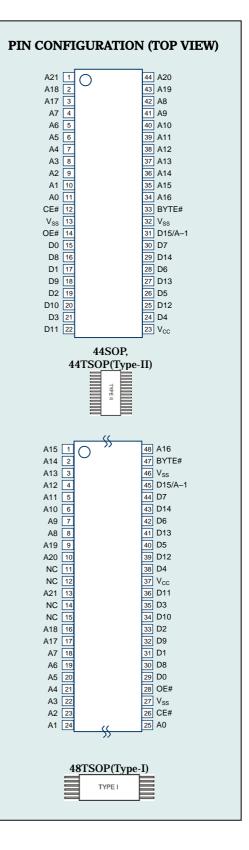
PACKAGES

 MR27T6402G-xxxMA 44-pin plastic SOP (SOP44-P-600-1.27-K)
 MR27T6402G-xxxTP 44-pin plastic TSOP (TSOP(2)44-P-400-0.80-K)
 MR27T6402G-xxxTN 48-pin plastic TSOP (TSOP(1)48-P-1220-0.50-K)

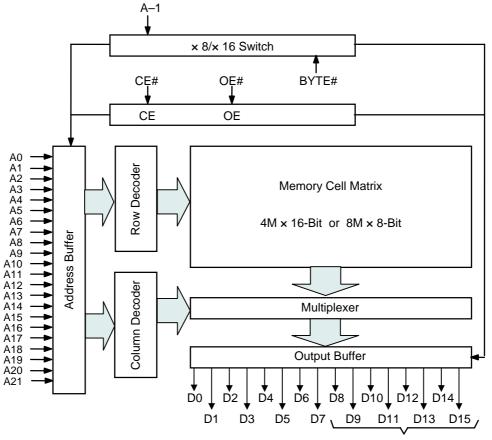
P2ROM ADVANCED TECHNOLOGY

P2ROM stands for Production Programmed ROM. This exclusive Oki technology utilizes factory test equipment for programming the customers code into the P2ROM prior to final production testing. Advancements in this technology allows production costs to be equivalent to MASKROM and has many advantages and added benefits over the other non-volatile technologies, which include the following;

- Short lead time, since the P2ROM is programmed at the final stage of the production process, a large P2ROM inventory "bank system" of un-programmed packaged products are maintained to provide an aggressive lead-time and minimize liability as a custom product.
- No mask charge, since P2ROMs do not utilize a custom mask for storing customer code, no mask charges apply.
- No additional programming charge, unlike Flash and OTP that require additional programming and handling costs, the P2ROM already has the code loaded at the factory with minimal effect on the production throughput. The cost is included in the unit price.
- Custom Marking is available at no additional charge.
- **Pin Compatible with Mask ROM** and some FLASH products.



BLOCK DIAGRAM



In 8-bit output mode, these pins are placed in a high-Z state and pin D15 functions as the A-1 address pin.

PIN DESCRIPTIONS

Pin name	Functions			
D15 / A–1	Data output / Address input			
A0 to A21	Address inputs			
D0 to D14	Data outputs			
CE#	Chip enable input			
OE#	Output enable input			
BYTE#	Word / Byte select input			
Vcc	Power supply voltage			
V _{SS}	Ground			
NC	No connect			

FUNCTION TABLE

Mode	CE#	OE#	BYTE#	V _{CC}	D0 to D7	D8 to D14	D15/A–1
Read (16-Bit)	L	L	Н			D _{OUT}	
Read (8-Bit)	L	L	L		D _{OUT}	Hi–Z	L/H
Output disable		Н	н	3.0 V	Hi–Z		
Output disable	L	п	L	3.0 V			*
Standby		-t-	н		11: 7		
Standby	Н	*	L			Hi–Z	

*: Don't Care (H or L)

ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Condition	Value	Unit
Operating temperature under bias	Та		0 to 70	°C
Storage temperature	Tstg	—	-55 to 125	°C
Input voltage	VI		–0.5 to V _{CC} +0.5	V
Output voltage	Vo	relative to V_{SS}	–0.5 to V _{CC} +0.5	V
Power supply voltage	V _{CC}		–0.5 to 5	V
Power dissipation per package	PD	_	1.0	W

RECOMMENDED OPERATING CONDITIONS

 $(Ta = 0 \text{ to } 70^{\circ}C)$

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
V _{CC} power supply voltage	V _{CC}		2.7	_	3.6	V
Input "H" level	V _{IH}	V_{CC} = 2.7 to 3.6 V	2.2	—	V _{CC} +0.5*	V
Input "L" level	V _{IL}		-0.5**	_	0.6	V

Voltage is relative to V_{SS} .

* : Vcc+1.5V(Max.) when pulse width of overshoot is less than 10ns.

** : -1.5V(Min.) when pulse width of undershoot is less than 10ns.

PIN CAPACITANCE

$(V_{CC} = 3.0)$	V, Ta = 25°C	, f = 1 MHz)
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Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Input	C _{IN1}	$V_1 = 0 V$	—	—	8	
BYTE#	C _{IN2}	$v_1 = 0 v$	_	—	200	pF
Output	COUT	$V_0 = 0 V$	_	—	10	

ELECTRICAL CHARACTERISTICS

DC Characteristics

				(\	/ _{CC} = 2.7 V	to 3.6 V, Ta	= 0 to 70°C)
Parameter	Symbol	Cor	dition	Min.	Тур.	Max.	Unit
Input leakage current	L	$V_1 = 0$) to V _{CC}		_	10	μA
Output leakage current	I _{LO}	$V_{O} = 0$ to V_{CC}			_	10	μA
V _{CC} power supply current	I _{ccsc}	$CE\# = V_{CC}$			_	10	μA
(Standby)	I _{CCST}	$CE\# = V_{IH}$			_	1	mA
V _{CC} power supply current	I _{CCA1}	$CE\# = V_{IL}$	tc = 100 ns	—	—	30	mA
(Read)	I _{CCA2}	$OE\# = V_{IH}$	tc = 200 ns	_	—	20	mA
Input "H" level	V _{IH}		_	2.2	—	V _{CC} +0.5*	V
Input "L" level	V _{IL}	—		-0.5**	_	0.6	V
Output "H" level	V _{OH}	I _{OH} = -1 mA		2.4	_	_	V
Output "L" level	V _{OL}	I _{OL} =	: 2 mA	_		0.4	V

Voltage is relative to V_{SS} .

* : Vcc+1.5V(Max.) when pulse width of overshoot is less than 10ns.

** : -1.5V(Min.) when pulse width of undershoot is less than 10ns.

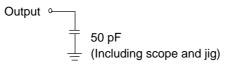
AC Characteristics

			(V _{CC} =	2.7 V to 3.6 V, Ta	= 0 to 70°C)
Parameter	Symbol	Condition	Min.	Max.	Unit
Address cycle time	t _C	—	90	_	ns
Address access time	t _{ACC}	$CE\# = OE\# = V_{IL}$	—	90	ns
CE# access time	t _{CE}	$OE\# = V_{IL}$	—	90	ns
OE# access time	t _{OE}	CE #= V _{IL}	—	30	ns
Output disable time	t _{CHZ}	$OE\# = V_{IL}$	0	30	ns
	t _{OHZ}	$CE\# = V_{IL}$	0	25	ns
Output hold time	t _{OH}	CE #= OE# = V_{IL}	0	—	ns

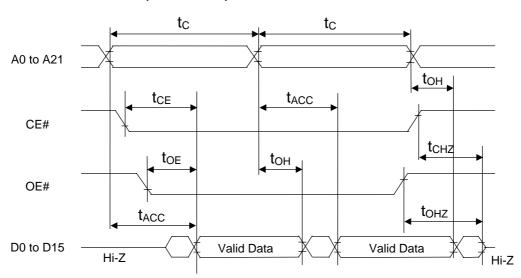
Measurement conditions

Input signal level) V/2.7 V	V
Input timing reference level1	/2Vcc	
Output load5	50 pF	
Output timing reference level1	/2Vcc	

Output load

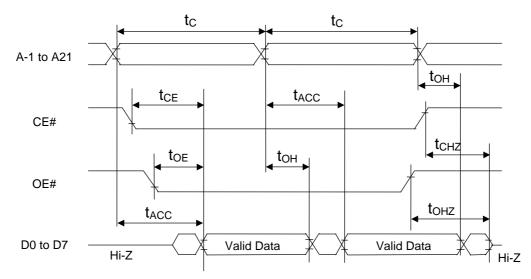


TIMING CHART (READ CYCLE)

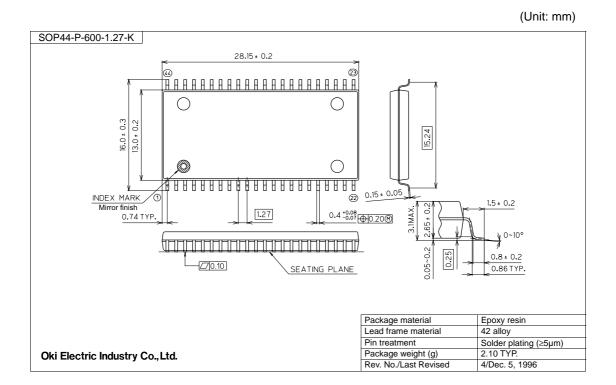


16-Bit Read Mode (BYTE# = VIH)

8-Bit Read Mode (BYTE# = VIL)



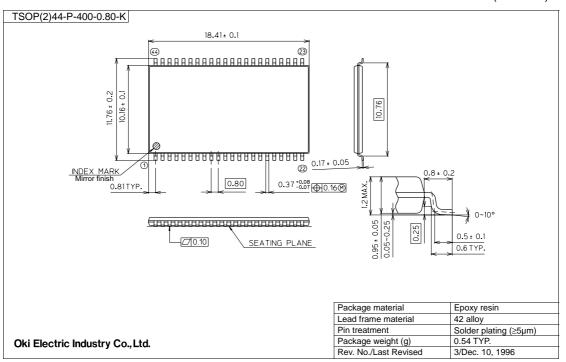
PACKAGE DIMENSIONS



Notes for Mounting the Surface Mount Type Package

The surface mount type packages are very susceptible to heat in reflow mounting and humidity absorbed in storage.

Therefore, before you perform reflow mounting, contact Oki's responsible sales person for the product name, package name, pin number, package code and desired mounting conditions (reflow method, temperature and times).

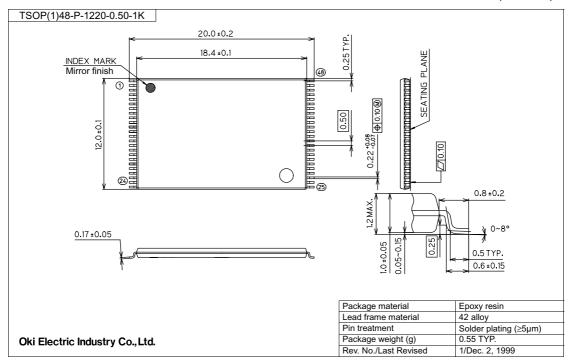


(Unit: mm)

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REVISION HISTORY

Document		Pa	ge		
No.	Date	Previous Current Edition Edition		Description	
FEDR27T6402G-02-01	Mar. 12, 2002	-	-	Final edition 1	

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